

DIFFERENTIAL OUTPUT SILICON OSCILLATOR

Features

- Quartz-free silicon oscillator
- Any-rate output frequencies from 0.9 to 200 MHz
- Quick turn delivery
- Highly reliable startup and operation
- Tri-state or power down operation
- 1.8, 2.5, or 3.3 V options

- LVPECL, LVDS, HCSL, differential CMOS, and differential SSTL versions available
- 3.2 x 4.0 mm footprint compatible with industry-standard 3.2 x 5.0 mm pinout
- Low power
- Pb-free and RoHS compliant



Specifications

Parameters	Condition	Min	Тур	Max	Units
quency Range		0.9	_	200	MHz
Frequency Stability	See Note 1.	_	_	±150	ppm
Operating Temperature		0	_	+70	C°
Storage Temperature		-55	_	+125	C°
	1.8 V option	1.71	_	1.98	V
Supply Voltage	2.5 V option	2.25	_	2.75	V
	3.3 V option	2.97	_	3.63	V
	LVPECL	_	34.0	36.0	mA
	Low Power LVPECL	_	19.3	22.2	mA
	LVDS	_	14.9	16.5	mA
	HCSL	_	25.3	29.3	mA
Cumply Current	Differential CMOS(3.3 V option,10 pF,200 MHz)	_	29.0	31.8	mA
Supply Current	Differential SSTL-3	_	24.5	27.7	mA
	Differential SSTL-2	_	24.3	26.7	mA
	Differential SSTL-18	_	22.2	25	mA
	Tri-State	_	9.7	10.7	mA
	Powerdown	_	1.0	1.9	mA
Output Symmetry	V _{DIFF} = 0	46 – 13 ns/T _{CLK}	_	54 + 13 ns/T _{CLK}	%
. ,	LVPECL/LVDS	_ OER	_	460	ps
Rise and Fall Times (20/80%) ²	HCSL/Differential SSTL	_	_	800	ps
(=0,00,00)	Differential CMOS, 15 pF, ≥80 MHz	_	1.1	1.6	ns
LVPECL Output Option	Mid-level	V _{DD} - 1.5	_	V _{DD} – 1.34	V
(DC coupling, 50 Ω to $V_{DD} - 2.0 \text{ V})^2$			_	.880	V_{PK}
Low Power LVPECL Output Option	Mid-level	_	N/A	1	V
(AC coupling, 100 Ω Differential Load) ²	upling, 100 Ω Differential Load) ² Diff swing		_	.95	V_{PK}
OS Output Option (2.5/3.3 V) Mid-level		1.15	_	1.26	V
$(R_{TERM} = 100 \Omega \text{ diff})^2$			_	0.45	V_{PK}
LVDS Output Option (1.8 V)	Output Option (1.8 V) Mid-level		_	0.96	V
$(R_{TERM} = 100 \Omega \text{ diff})^2$	Diff swing	0.25	_	0.45	V_{PK}
	Mid-level	0.35	_	.425	V
HCSL Output Option ²	Diff swing	0.65	_	.82	V_{PK}
	DC termination per pad	45	_	55	Ω
2	V _{OH} , sourcing 9 mA	V _{DD} - 0.6	_	_	V
CMOS Output Voltage ²	V _{OL} , sinking 9 mA		_	0.6	V
	SSTL-18	.5 x V _{DD} + 0.375	_	.5 x V _{DD} - 0.375	V
SSTL Output Voltage ²	SSTL-2	.5 x V _{DD} + 0.48	_	.5 x V _{DD} - 0.48	V
	SSTL-3	.45 x V _{DD} + 0.48	_	.45 V _{DD} – 0.48	V
Powerup Time	From time V _{DD} crosses min spec supply	_	_	2	ms
OE Deassertion to Clk Stop	22	_	_	250 + 3 x T _{CLK}	ns
Return from Output Driver Stopped Mode		_	_	250 + 3 x T _{CLK}	ns
Return From Tri-State Time		_	_	12 + 3 x T _{CLK}	μs
Return From Powerdown Time		_	_	2	ms
David litter (4 sigms)	Non-CMOS	_	1	2	ps RMS
Period Jitter (1-sigma)	CMOS, C _L = 7 pF	_	1	3	ps RMS
	1.0 MHz – min(20 MHz, 0.4 x F _{OUT}),non-CMOS	_	0.6	1	ps RMS
Integrated Phase Jitter	1.0 MHz – min(20 MHz, 0.4 x F _{OUT}),CMOS format	_	0.7	1.5	ps RMS

Notes:

- 1. Inclusive of 25 C° initial frequency accuracy, operating temperature range, supply voltage change, output load change, 1st year aging at 25 C°, shock and vibration.
- See AN409 for further details regarding output clock termination recommendations. SSTL minimum output voltage is minimum V_{OH}. SSTL maximum output voltage is maximum V_{OL}.

Package Specifications

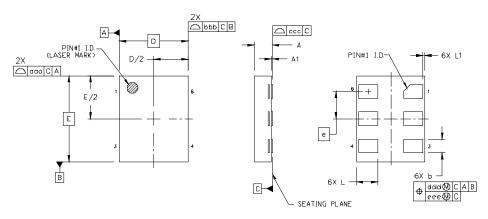


Table 1. Package Diagram Dimensions (mm)

Dimension	Min	Nom	Max	
Α	0.80	0.85	0.90	
A1	0.00	0.03	0.05	
b	0.59	0.64	0.69	
D	3.20 BSC.			
е	1.27 BSC.			
E	4.00 BSC.			
L	0.95	1.00	1.05	

Dimension	Min	Nom	Max	
L1	0.00	0.05	0.10	
aaa	_	_	0.10	
bbb	_	_	0.10	
CCC	_	_	0.08	
ddd	_	_	0.10	
eee	_	_	0.05	

Table 2. Pad Connections

1	OE	
2	NC—Make no external connection to this pin	
3	GND	
4	Output	
5	Complementary Output	
6	VDD	

Dimension (mm)
C1 2.70
E 1.27
X1 0.75
Y1 1.55

Figure 1. Recommended Land Pattern

Table 3. Tri-State/Powerdown/Driver Stopped Function on OE (3rd Option Code)

	Α	В	С	D	E	F
Open	Active	Active	Active	Active	Active	Active
1 Level	Active	Tri- State	Active	Power- down	Active	Driver Stopped
0 Level	Tri- State	Active	Power- down	Active	Driver Stopped	Active

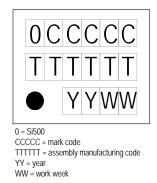


Figure 2. Top Mark



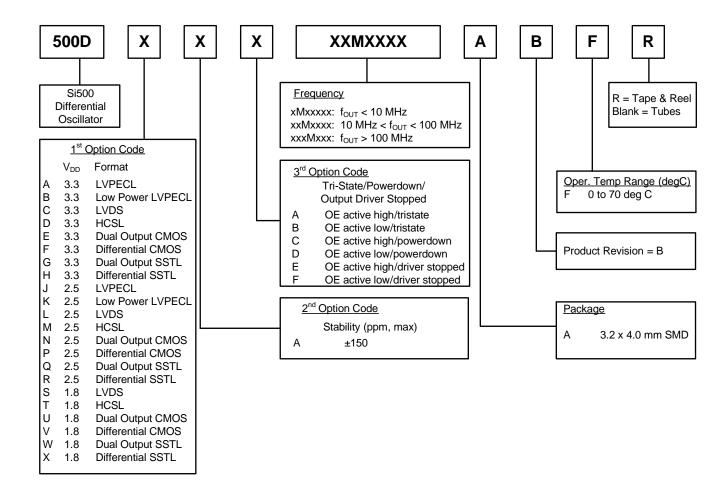
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Environmental Compliance

Parameter	Conditions/Test Method		
Mechanical Shock	MIL-STD-883, Method 2002.4		
Mechanical Vibration	MIL-STD-883, Method 2007.3 A		
Resistance to Soldering Heat	MIL-STD-202, 260 C° for 8 seconds		
Solderability	MIL-STD-883, Method 2003.8		
Damp Heat	IEC 68-2-3		
Moisture Sensitivity Level	J-STD-020, MSL 3		

Ordering Information

The Si500D supports a variety of options including frequency, output format, supply voltage, and tristate/powerdown. Specific device configurations are programmed into the Si500D at time of shipment. Configurations are specified using the figure below. Silicon Labs provides a web-based part number utility that can be used to simplify part number configuration. Refer to www.silabs.com/XOPartNumber to access this tool. The Si500D XO series is supplied in a ROHS-compliant, Pb-free, 6-pad, 3.2 x 4.0 mm package. Tape and reel packaging is available as an ordering option.





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Si500D

CONTACT INFORMATION

Silicon Laboratories Inc.

400 West Cesar Chavez Austin, TX 78701 Tel: 1+(512) 416-8500 Fax: 1+(512) 416-9669 Toll Free: 1+(877) 444-3032

Email: XOinfo@silabs.com Internet: www.silabs.com

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